

Data sheet acquired from Harris Semiconductor SCHS250A

August 1998 - Revised May 2000

# 9-Bit Odd/Even Parity Generator/Checker

#### **Features**

- Buffered Inputs
- Typical Propagation Delay
  - 10ns at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}C$ ,  $C_L = 50pF$
- Exceeds 2kV ESD Protection per MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST<sup>™</sup>/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
  - Fanout to 15 FAST™ ICs
  - Drives  $50\Omega$  Transmission Lines

# Description

The 'AC280 and 'ACT280 are 9-bit odd/even parity generator/checkers that utilize Advanced CMOS Logic technology. Both even and odd parity outputs are available for checking or generating parity for words up to nine bits long. Even parity is indicated (ΣE output is HIGH) when an even number of

data inputs is HIGH. Odd parity is indicated ( $\Sigma$ O output is HIGH) when an odd number of data inputs is HIGH. Parity checking for words larger than nine bits can be accomplished by tying the  $\Sigma$ E output to any input of an additional 'AC280, 'ACT280 parity checker.

# **Ordering Information**

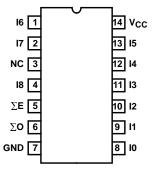
PART NUMBER	TEMP. RANGE ( <sup>O</sup> C)	PACKAGE
CD54AC280F3A	-55 to 125	14 Ld CERDIP
CD74AC280E	0 to 70 <sup>o</sup> C, -40 to 85, -55 to 125	14 Ld PDIP
CD74AC280M	0 to 70 <sup>o</sup> C, -40 to 85, -55 to 125	14 Ld SOIC
CD54ACT280F3A	-55 to 125	14 Ld CERDIP
CD74ACT280E	0 to 70°C, -40 to 85, -55 to 125	14 Ld PDIP
CD74ACT280M	0 to 70°C, -40 to 85, -55 to 125	14 Ld SOIC

#### NOTES:

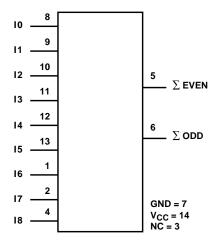
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

#### **Pinout**

CD54AC280, CD54ACT280 (CERDIP) CD74AC280, CD74ACT280 (PDIP, SOIC) TOP VIEW



# Functional Diagram



## CD54/74AC280, CD54/74ACT280

# **Absolute Maximum Ratings**

DC Supply Voltage, V <sub>CC</sub> 0.5V to 6V
DC Input Diode Current, I <sub>IK</sub>
For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$
DC Output Diode Current, I <sub>OK</sub>
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V <sub>CC</sub> or Ground Current, I <sub>CC or</sub> I <sub>GND</sub> (Note 3) ±100mA

#### **Thermal Information**

Thermal Resistance (Typical, Note 5)	θ <sub>JA</sub> ( <sup>o</sup> C/W)
PDIP Package	
SOIC Package	·
Maximum Junction Temperature (Plastic Package)	150 <sup>0</sup> C
Maximum Storage Temperature Range	65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C

## **Operating Conditions**

Temperature Range, T <sub>A</sub> 55°C to 125°C Supply Voltage Range, V <sub>CC</sub> (Note 4)
AC Types1.5V to 5.5V
ACT Types
DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> 0V to V <sub>CC</sub>
Input Rise and Fall Slew Rate, dt/dv
AC Types, 1.5V to 3V 50ns (Max)
AC Types, 3.6V to 5.5V
ACT Types, 4.5V to 5.5V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTES:

- 3. For up to 4 outputs per device, add  $\pm 25 \text{mA}$  for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

### **DC Electrical Specifications**

		TEST   CONDITIONS   V <sub>I</sub> (V)   I <sub>O</sub> (mA)		v <sub>cc</sub>	25°C		-40°C TO 85°C		-55°C TO 125°C		
PARAMETER	SYMBOL			(v)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
AC TYPES											
High Level Input Voltage	V <sub>IH</sub>	-	-	1.5	1.2	-	1.2	-	1.2	-	V
				3	2.1	-	2.1	-	2.1	-	V
				5.5	3.85	-	3.85	-	3.85	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	1.5	-	0.3	-	0.3	-	0.3	V
				3	-	0.9	-	0.9	-	0.9	V
				5.5	-	1.65	-	1.65	-	1.65	V
High Level Output Voltage	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.05	1.5	1.4	-	1.4	-	1.4	-	V
			-0.05	3	2.9	-	2.9	-	2.9	-	V
			-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-4	3	2.58	-	2.48	-	2.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V

# CD54/74AC280, CD54/74ACT280

## DC Electrical Specifications (Continued)

		1	ST ITIONS	v <sub>cc</sub>	25	o°C		C TO		C TO 5°C	
PARAMETER	SYMBOL	V <sub>I</sub> (V)	I <sub>O</sub> (mA)	(v)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
Low Level Output Voltage	$V_{OL}$	V <sub>IH</sub> or V <sub>IL</sub>	0.05	1.5	-	0.1	-	0.1	-	0.1	V
			0.05	3	-	0.1	-	0.1	-	0.1	V
			0.05	4.5	-	0.1	-	0.1	-	0.1	V
			12	3	-	0.36	-	0.44	-	0.5	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	lį	V <sub>CC</sub> or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	-	8	-	80	-	160	μА
ACT TYPES											
High Level Input Voltage	V <sub>IH</sub>	-	-	4.5 to 5.5	2	-	2	-	2	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	4.5 to 5.5	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V
Low Level Output Voltage	$V_{OL}$	V <sub>IH</sub> or V <sub>IL</sub>	0.05	4.5	-	0.1	-	0.1	-	0.1	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	l <sub>l</sub>	V <sub>CC</sub> or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	Icc	V <sub>CC</sub> or GND	0	5.5	-	8	-	80	-	160	μΑ
Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load	Δl <sub>CC</sub>	V <sub>CC</sub> -2.1	-	4.5 to 5.5	-	2.4	-	2.8	-	3	mA

#### NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum  $50\Omega$  transmission-line-drive capability at  $85^{\circ}$ C,  $75\Omega$  at  $125^{\circ}$ C.

# **ACT Input Load Table**

INPUT	UNIT LOAD
All	1.43

NOTE: Unit load is  $\Delta I_{CC}$  limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25°C.

## CD54/74AC280, CD54/74ACT280

## **Switching Specifications** Input $t_r$ , $t_f$ = 3ns, $C_L$ = 50pF (Worst Case)

			-40°	C TO 85°	С	-55			
PARAMETER	SYMBOL	V <sub>CC</sub> (V)	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
AC TYPES					•			•	
Propagation Delay,	t <sub>PLH</sub> , t <sub>PHL</sub>	1.5	-	-	239	-	-	263	ns
Any Input to $\Sigma O$		3.3 (Note 9)	7.5	-	26	7.3	-	29	ns
		5 (Note 10)	5.4	-	19.1	5.3	-	21	ns
Propagation Delay,	t <sub>PLH</sub> , t <sub>PHL</sub>	1.5	-	-	227	-	-	250	ns
Any Input to ∑E		3.3	7.2	-	25	7	-	28	ns
		5	5.2	-	18.2	5	-	20	ns
Input Capacitance	Cl	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C <sub>PD</sub> (Note 11)	-	-	115	-	-	115	-	pF
ACT TYPES				•				•	
Propagation Delay, Any Input to $\Sigma$ O	t <sub>PLH</sub> , t <sub>PHL</sub>	5 (Note 10)	5.6	-	19.6	5.4	-	21.6	ns
Propagation Delay, Any Input to $\Sigma E$	t <sub>PLH</sub> , t <sub>PHL</sub>	5	5.6	-	19.6	5.4	-	21.6	ns
Input Capacitance	C <sub>I</sub>	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C <sub>PD</sub> (Note 11)	-	-	115	-	-	115	-	pF

#### NOTES:

- 8. Limits tested 100%
- 9. 3.3V Min is at 3.6V, Max is at 3V.
- 10. 5V Min is at 5.5V, Max is at 4.5V.
- 11. C<sub>PD</sub> is used to determine the dynamic power consumption per package.

AC: 
$$P_D = V_{CC}^2 f_i (C_{PD} + C_L)$$

AC:  $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$  +  $V_{CC} \Delta I_{CC}$  where  $f_i$  = input frequency,  $C_L$  = output load capacitance,  $V_{CC}$  = supply voltage.

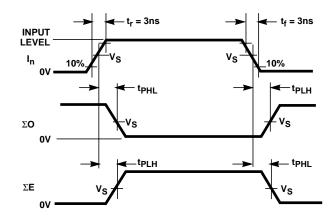
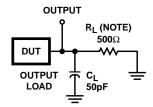


FIGURE 1.



NOTE: For AC Series Only: When  $V_{CC}$  = 1.5V,  $R_L$  = 1k $\Omega$ .

	AC	ACT
Input Level	V <sub>CC</sub>	3V
Input Switching Voltage, V <sub>S</sub>	0.5 V <sub>CC</sub>	1.5V
Output Switching Voltage, V <sub>S</sub>	0.5 V <sub>CC</sub>	0.5 V <sub>CC</sub>

FIGURE 2. PROPAGATION DELAY TIMES

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#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
CD54AC280F3A	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54AC280F3A	Samples
CD54ACT280F3A	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54ACT280F3A	Samples
CD74AC280E	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74AC280E	Samples
CD74AC280M	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC280M	Samples
CD74AC280M96	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC280M	Samples
CD74AC280M96G4	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC280M	Samples
CD74ACT280E	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74ACT280E	Samples
CD74ACT280M	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT280M	Samples
CD74ACT280M96	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT280M	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

# PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD54AC280, CD54ACT280, CD74AC280, CD74ACT280:

Catalog: CD74AC280, CD74ACT280

■ Military: CD54AC280, CD54ACT280

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74AC280M96	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
CD74ACT280M96	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

# **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD74AC280M96	SOIC	D	14	2500	853.0	449.0	35.0
CD74ACT280M96	SOIC	D	14	2500	853.0	449.0	35.0

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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